## TPRH8D43 TYPE

#### **FEATURE**

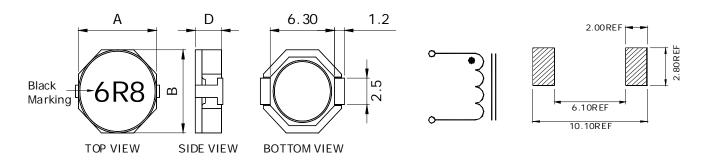
- 1. High current capacity and Low DCR
- 2. Magnetic shielded for low raditation

#### Applications

- 1. Portable telephone, Personal Computer
- 2. Set top box, and other electronic equipment

### Shape and Dimension

### Schematics and Land Patterns(mm)



#### A=8.30m/m MAX; D=4.50m/m MAX; MARKING= Inductance value

### Specification

P/N	L	Marking	RDC	Isat	Irms
	(µH)		(Ω)Max	(A)	(A)
TPRH8D43-2R0□	2.0	2R0	14.0m	7.00	5.50
TPRH8D43-3R3	3.3	3R3	18.5m	6.00	5.00
TPRH8D43-3R9□	3.9	3R9	19.0m	5.90	4.50
TPRH8D43-4R7□	4.7	4R7	22.0m	5.60	4.10
TPRH8D43-6R8□	6.8	6R8	25.0m	4.40	3.90
TPRH8D43-100	10	100	36.0m	4.00	3.20
TPRH8D43-150	15	150	53.0m	2.90	2.30
TPRH8D43-220	22	220	75.0m	2.60	1.80
TPRH8D43-330	33	330	125m	2.20	1.40
TPRH8D43-470	47	470	150m	1.80	1.30
TPRH8D43-560	56	560	220m	1.60	1.10
TPRH8D43-680	68	680	300m	1.50	1.00
TPRH8D43-820	82	820	340m	1.35	0.80
TPRH8D43-101□	100	101	364m	1.30	0.80

Note1. Measurement frequency of Inductance value: at 100KHz, 0.25V

Note2. Measurement ambient temperature of L, DCR and IDC : at  $25^{\circ}$ C

Note3. Isat: DC current at which the inductance drops 35%(max) from its value without current

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## SMD POWER INDUCTOR-RoHS

Note5. Inductance tolerance: N: ±30%; M: ±20% Note6. Ordering Code: TYPE NAME: TPRH8D43

Main Inductance: 100 (10uH)

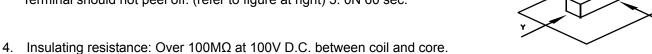
Tolerance: M (±20%)

Note7.Packaging: Taping; Quantity: TPRH8D43:1000 Pieces/reel

### GENERAL CHARACTERISTICS

- Operating temperature range: -40 TO + 105°C (Includes temperature when the coil is heated)
- 2. External appearance: On visual inspection, the coil has no external defects.
- Terminal strength: After soldering. Between copper plate and terminals of coil. Push in two directions of X.Ywithstanding at below conditions.

Terminal should not peel off. (refer to figure at right) 5. 0N 60 sec.



- Dielectric strength: No dielectric breakdown at 100V D.C. for 1 minute between coil and core.
- Temperature characteristics: Inductance coefficient (0~2,000)x10-6/°C (-25~+80°C).
- Humidity characteristics(Moisture Resistance): Inductance deviation within ±5%, after 96 hours in 90~95% relative humidity at 40 ±2°C and 1 hour drying under normal condition.
- 8. Vibration resistance: Inductance deviation within ±5%, after vibration for 1 hour. In each of three orientations at sweep vibration (10~55~10 Hz) with 1.5mm P-P amplitudes.
- 9. Shock resistance: Inductance deviation within ±5%, after being dropped once with 981m/s2 (100G) shock attitude upon a rubber block method shock testing machine, in three different orientations.
- 10. Resistance to Soldering Heat: 260°C, 10 seconds(See attached recommend reflow)
- 11. Storage environment: Storage condition: Temperature Range: 10°C ~ 35°C (Generally: 21°C ~ 31°C) , Humidity Range: 50% ~ 80% RH (Generally: 65% ~ 75%); Transportation condition: Temperature Range: -35°C ~ 85°C , Humidity Range: 50% ~ 95% RH
- 12. Use components within 12 months. If 12 months or more have elapsed, check solderability before use.
- 13. Reflow profile recommend:

#### Lead-free heat endurance test

#### Lead-free the recommended reflow condition

